

IMPROVED INTEGRATED CHIP PACKAGE
HAVING INTERMEDIATE SUBSTRATE
SEHAT SUTARDJA
MP0115
SHEET 1/3

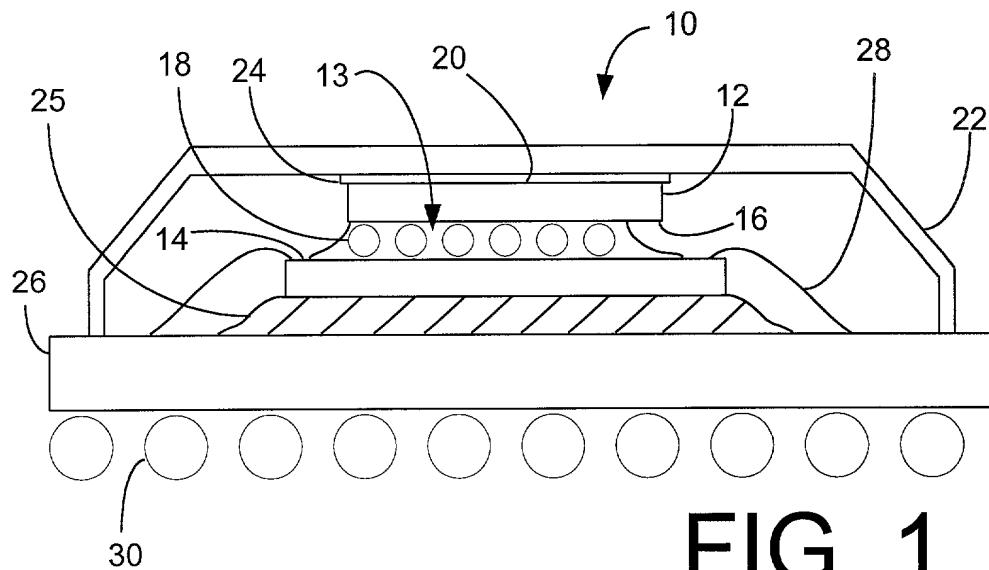


FIG. 1

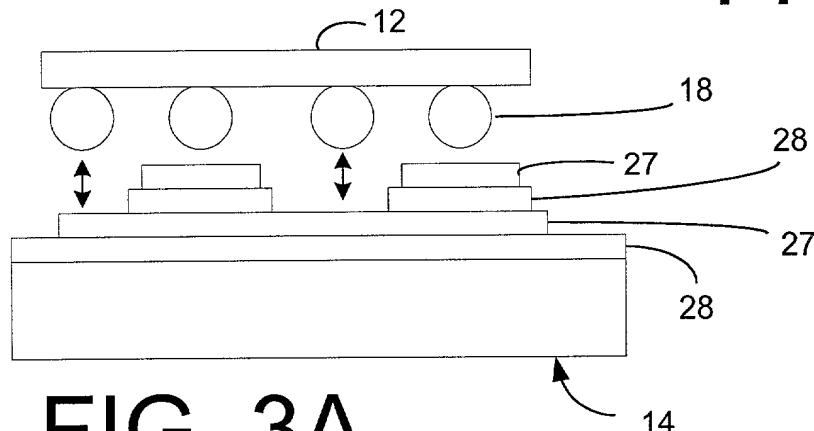


FIG. 3A

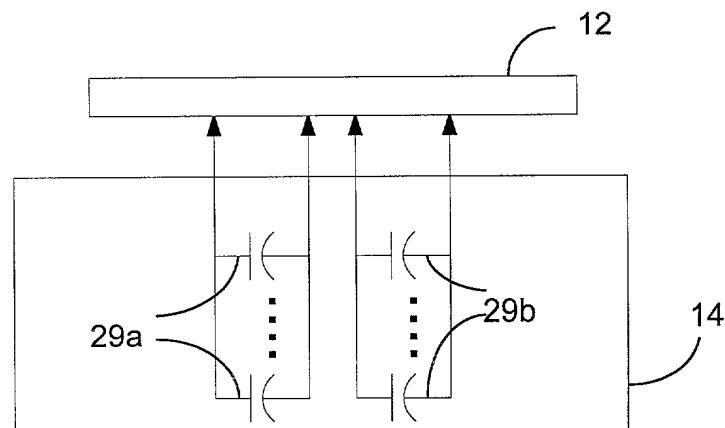


FIG. 3B

IMPROVED INTEGRATED CHIP PACKAGE
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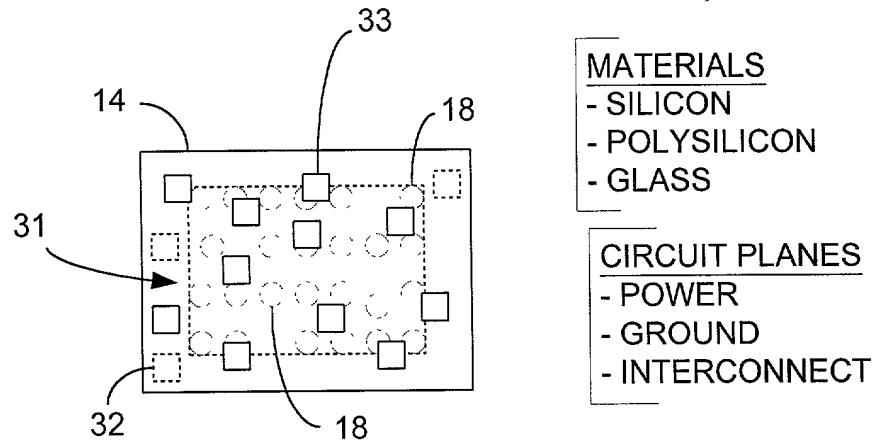


FIG. 2

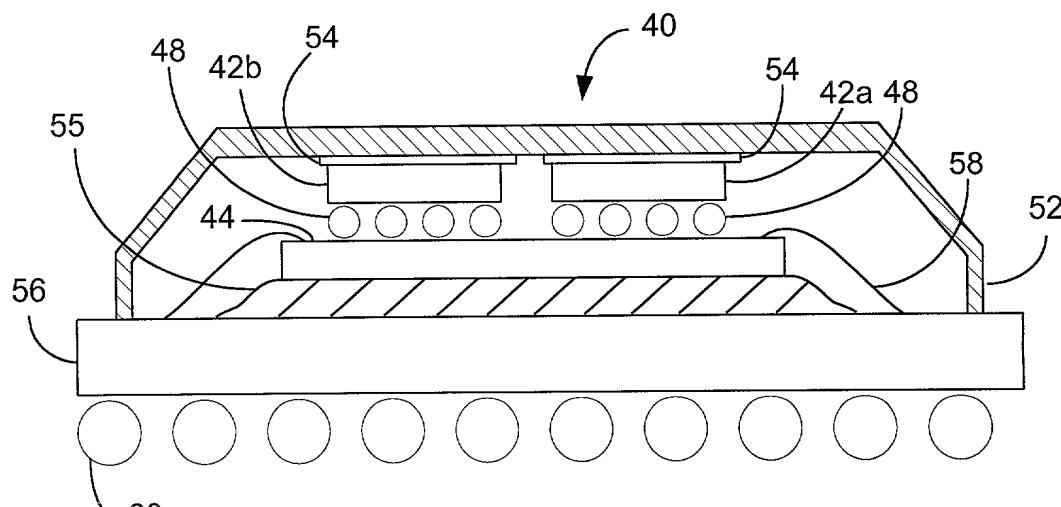


FIG. 4

IMPROVED INTEGRATED CHIP PACKAGE

HAVING INTERMEDIATE SUBSTRATE

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SHEET 3/3

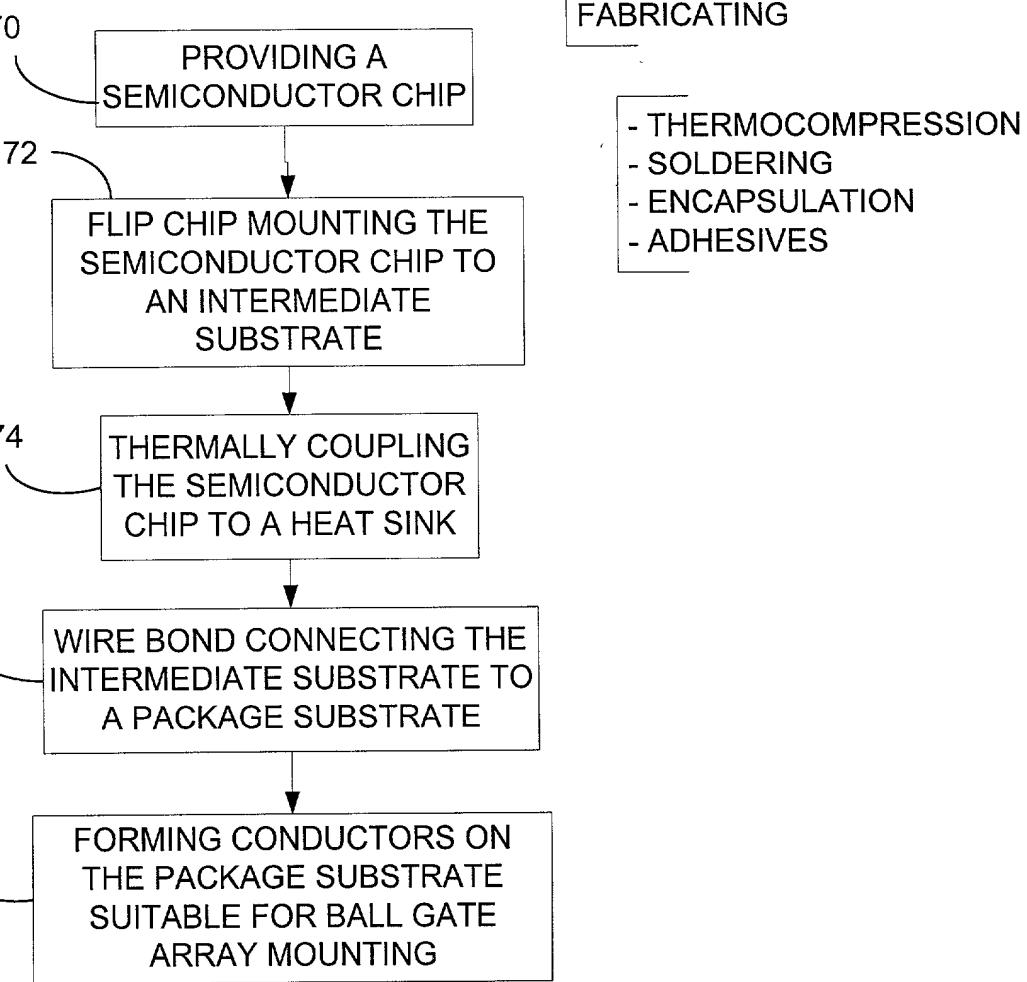


FIG. 5